



1753

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re application of

Akihisa HONGO et al.

Serial No. 09/762,582

Filed April 12, 2001

Confirmation No. 5731

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Group Art Unit 1753

Examiner Brian Mutschler

SUBSTRATE PLATING
METHOD AND APPARATUS

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TC 1700

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Attached hereto is a check in the amount of \$1,240.00 to cover Patent Office fees relating to filing the following attached papers:

Petition for Extension of Time \$950.00

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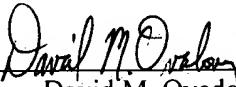
A duplicate copy of this paper is being submitted for use in the Accounting Division, Office of Finance.

The Commissioner is authorized to charge any deficiency or to credit any overpayment associated with this communication to Deposit Account No. 23-0975, with the EXCEPTION of deficiencies in fees for multiple dependent claims in new applications.

Respectfully submitted,

Akihisa HONGO et al.

By


David M. Ovedovitz
Registration No. 45,336
Attorney for Applicants

DMO/jmj

WENDEROTH, LIND & PONACK, L.L.P.

2033 K St., N.W., Suite 800

Washington, D.C. 20006-1021

Telephone (202) 721-8200

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